

Unterpremstätten, April 2010

Subject: Wafer fabrication transfer PCN 09-2010

Dear Customer,

Pleased be informed, that austriamicrosystems AG will be transferring your product AS253x (Single Chip Telephone) to X-Fab Germany in order to reasonably protect the supply of your products and to assure additional flexibility and capacity needed to further improve responsiveness and on time delivery. Currently, your product is fabricated in austriamicrosystems 8" wafer fabrication.

This will enable us to better support the ever increasing demand in today's dynamic market environment and to have an alternative and ready solution for manufacturing issues like tight-line capacity situation, on-allocation situation, and any other manufacturing issues that can arise and potentially prevent austriamicrosystems AG from meeting the customer demand on-time.

X-Fab Germany has been a qualified manufacturing partner of austriamicrosystems AG for years. X-Fab is certified in accordance with the ISO9001 and the automotive quality system requirements, TS16949. The technology is mature, qualified and fully compatible to austriamicrosystems technology.

This change covers only the wafer fabrication of the product. Testing and backend services will all be unchanged.

The following product will be affected:

AS253x (sorted wafers)
AS2533, AS2534, AS2535, AS2536

Timing of change:

The supplemental wafer fabrication will be qualified until May 2010.

Set of qualification tests:

austriamicrosystems AG will be qualifying the transferred products based on the following tests:

ESD Test

Latch up Test

Electrical distribution

Detailed activities and an actual status of the qualification are available upon request.

If you do have further questions please do not hesitate to contact us.

Please be advised that unless we receive your written refusal concerning this PCN within 30 days, the PCN shall be deemed accepted.

Best regards,

austriamicrosystems AG



Herwig Klimesch
Director Quality & Environment